FAIRCHILD SEMICONDUCTOR

# FGH40T120SMD / FGH40T120SMD\_F155 1200 V, 40 A FS Trench IGBT

### Features

- FS Trench Technology, Positive Temperature Coefficient
- · High Speed Switching
- Low Saturation Voltage: V<sub>CE(sat)</sub> =1.8 V @ I<sub>C</sub> = 40 A
- 100% of the Parts tested for I<sub>LM</sub>(1)
- High Input Impedance
- RoHS Compliant

### Applications

• Solar Inverter, Welder, UPS & PFC applications.

### **General Description**

Using innovative field stop trench IGBT technology, Fairchild®, s new series of field stop trench IGBTs offer the optimum performance for hard switching application such as solar inverter, UPS, welder and PFC applications.

July 2013

## COLLECTOR (FLANGE)

### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

| Symbol              | Description  |                                       | Ratings     | Unit |
|---------------------|--|---------------------------------------|-------------|------|
| V <sub>CES</sub>    | Collector to Emitter Voltage   |                                       | 1200        | V    |
| V <sub>GES</sub>    | Gate to Emitter Voltage  |                                       | ±25         | V    |
|                     | Transient Gate to Emitter Voltage  |                                       | ±30         | V    |
| I <sub>C</sub>      | Collector Current  | @ T <sub>C</sub> = 25°C               | 80          | A    |
| 'C                  | Collector Current  | @ T <sub>C</sub> = 100 <sup>o</sup> C | 40          | A    |
| I <sub>LM</sub> (1) | Clamped Inductive Load Current   | @ T <sub>C</sub> = 25 <sup>o</sup> C  | 160         | А    |
| I <sub>CM</sub> (2) | Pulsed Collector Current   |                                       | 160         | А    |
| I <sub>F</sub>      | Diode Continuous Forward Current   | @ T <sub>C</sub> = 25 <sup>o</sup> C  | 80          | А    |
|                     | Diode Continuous Forward Current   | @ T <sub>C</sub> = 100°C              | 40          | А    |
| I <sub>FM</sub>     | Diode Maximum Forward Current  |                                       | 240         | А    |
| P <sub>D</sub>      | Maximum Power Dissipation  | @ T <sub>C</sub> = 25°C               | 555         | W    |
|                     | Maximum Power Dissipation  | @ T <sub>C</sub> = 100°C              | 277         | W    |
| TJ                  | Operating Junction Temperature   |                                       | -55 to +175 | °C   |
| T <sub>stg</sub>    | Storage Temperature Range  |                                       | -55 to +175 | °C   |
| TL                  | Maximum Lead Temp. for soldering<br>Purposes, 1/8" from case for 5 seconds |                                       | 300         | °C   |

### **Thermal Characteristics**

| Symbol  | Parameter                               | Тур. | Max. | Unit |
|---|---|------|------|------|
| R <sub>θJC</sub> (IGBT)                                       | Thermal Resistance, Junction to Case    |      | 0.27 | °C/W |
| R <sub>0JC</sub> (Diode) Thermal Resistance, Junction to Case |   |      | 0.89 | °C/W |
| $R_{	extsf{	heta}JA}$   | Thermal Resistance, Junction to Ambient |      | 40   | °C/W |

#### Notes:

1. Vcc = 600 V,V\_{GE} = 15 V, I\_C = 160 A, R\_G = 10  $\, \Omega \, , \,\,$  Inductive Load 2. Limited by Tjmax

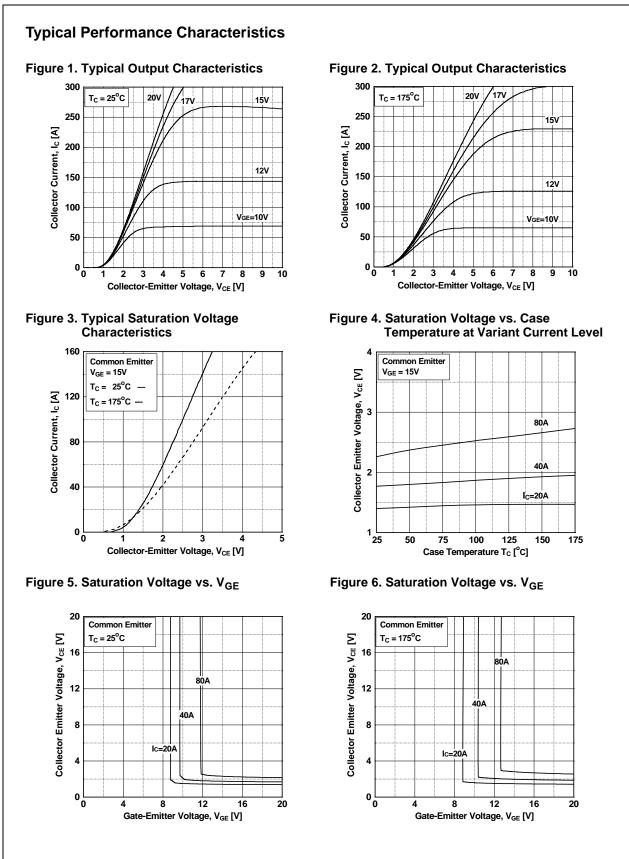
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| Device MarkingDeviceFGH40T120SMDFGH40T120SMDFGH40T120SMDFGH40T120SMD_F155 |   | Device                      | Package   | Reel Size  | Tape Width |            | Quantity<br>30 |           |
|---|---|-----------------------------|---|--|------------|------------|----------------|-----------|
|   |   | FGH40T120SMD                | TO-247 A03  |  |            |            |                |           |
|   |   | TO-247G03 -                 |   | -  |            | 30         |                |           |
| Electric  | al Chai                                 | racteristics of the         | <b>IGBT</b> T <sub>C</sub> = 25℃                                    | unless otherwise noted                                     |            |            |                |           |
| Symbol  |   | Parameter                   | Test Co   | Test Conditions  |            | Тур.       | Max.           | Unit      |
| Off Charac  | teristics                               |                             |   |  |            |            |                |           |
| BV <sub>CES</sub>   | Collector                               | to Emitter Breakdown Voltag | ge V <sub>GE</sub> = 0 V, I <sub>C</sub> =                          | = 250 uA   | 1200       | -          | -              | V         |
| I <sub>CES</sub>  | Collector                               | Cut-Off Current             |   | $V_{CE} = V_{CES}, V_{GE} = 0 V$                           |            | -          | 250            | uA        |
| I <sub>GES</sub>  | G-E Leak                                | age Current                 | $V_{GE} = V_{GES}, V$   |  | -          | -          | ±400           | nA        |
| On Charac   | teristics                               |                             |   |  |            |            |                |           |
| V <sub>GE(th)</sub>   |   | shold Voltage               | I <sub>C</sub> = 40 mA, V <sub>C</sub>                              | <sub>CE</sub> = V <sub>GE</sub>                            | 4.9        | 6.2        | 7.5            | V         |
|   |   | -                           | $I_{C} = 40 \text{ A}, V_{GE}$<br>$T_{C} = 25^{\circ}\text{C}$      |  | -          | 1.8        | 2.4            | V         |
| V <sub>CE(sat)</sub>  | Collector to Emitter Saturation Voltage |                             |   | = 15 V,  | -          | 2.0        | -              | V         |
| Dynamic C   | haracteris                              | tics                        |   | •  |            | -          |                |           |
| C <sub>ies</sub>  | Input Cap                               |                             |   |  | -          | 4300       | -              | pF        |
| C <sub>oes</sub>  | Output Ca                               | apacitance                  |   | V <sub>CE</sub> = 30 V, V <sub>GE</sub> = 0 V,<br>f = 1MHz |            | 180        | -              | pF        |
| C <sub>res</sub>  | Reverse <sup>-</sup>                    | Transfer Capacitance        | T = 1MHZ  |  |            | 100        | -              | pF        |
|   |   |                             |   |  |            |            |                |           |
| Switching   |   | ristics<br>Delay Time       |   |  | -          | 40         | -              | ns        |
| t <sub>d(on)</sub>  | Rise Time                               |                             |   |  |            | 40         | -              | ns        |
| t <sub>r</sub>  |   | -<br>Delay Time             |   | 10.4   | -          | 475        | -              | ns        |
| t <sub>d(off)</sub>   | Fall Time                               |                             | V <sub>CC</sub> = 600 V, I<br>R <sub>G</sub> = 10 Ω, V <sub>G</sub> | <sub>C</sub> = 40 A,<br><sub>F</sub> = 15 V,               | -          | 10         | _              | ns        |
| ч<br>Е <sub>on</sub>  |   | Switching Loss              | Inductive Load  | l, T <sub>C</sub> = 25°C                                   | -          | 2.7        | -              | mJ        |
|   |   | Switching Loss              | _   |  | -          | 1.1        | -              | mJ        |
| E <sub>off</sub><br>E <sub>ts</sub>                                       |   | tching Loss                 |   |  | -          | 3.8        | -              | mJ        |
|   |   | Delay Time                  |   |  | -          | 40         | -              | ns        |
| t <sub>d(on)</sub>  | Rise Time                               | ,                           |   |  | -          | 55         | -              |           |
| t <sub>r</sub>  |   | -<br>Delay Time             |   | 10.1   | -          | 520        | -              | ns<br>ns  |
| t <sub>d(off)</sub>   | Fall Time                               | ,                           | V <sub>CC</sub> = 600 V, I<br>R <sub>G</sub> = 10 Ω, V <sub>G</sub> |  | -          | 520        | -              |           |
| t <sub>f</sub><br>⊨   |   | Switching Loss              | Inductive Load  |  | -          | 3.4        | -              | ns<br>m l |
| E <sub>on</sub>   |   | Switching Loss              | _   |  | -          | 2.5        | -              | mJ<br>mJ  |
| E <sub>off</sub>  |   | tching Loss                 |   |  | -          | 2.5<br>5.9 | -              | mJ        |
| E <sub>ts</sub>   |   | e Charge                    |   |  | -          |            | -              |           |
| 0   |   |                             |   |  | -          | 370        | -              | nC        |
| Q <sub>g</sub><br>Q <sub>ge</sub>   |   | mitter Charge               | V <sub>CE</sub> = 600 V, I  | <sub>C</sub> = 40 A,                                       | -          | 23         | -              | nC        |

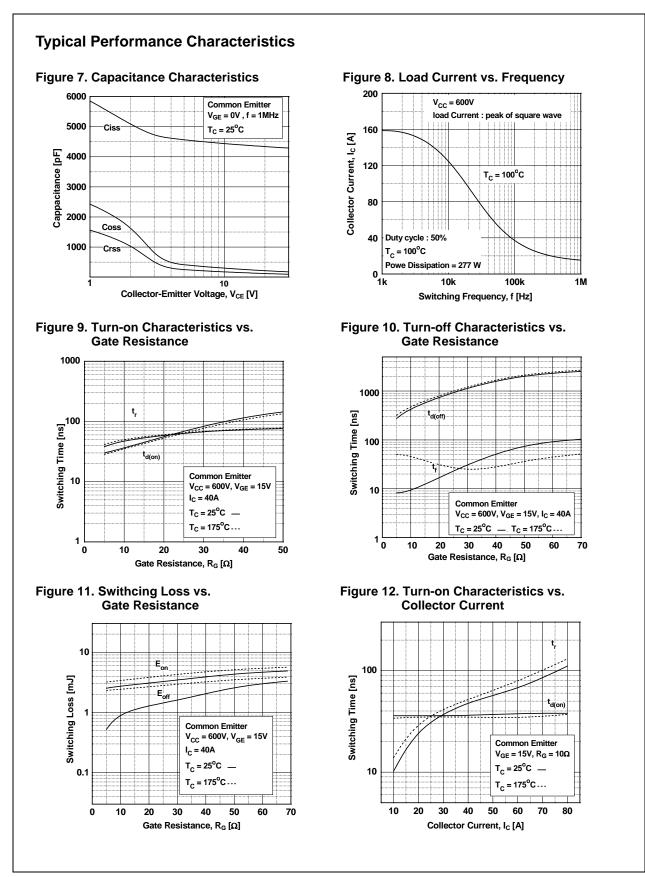
| FGH40T120SMD /                      |
|-------------------------------------|
| FGH40T120SMD_                       |
| F155 1200                           |
| ID_F155 1200 V, 40 A FS Trench IGBT |
| rench IGBT                          |

### Electrical Characteristics of the DIODE T<sub>c</sub> = 25°C unless otherwise noted

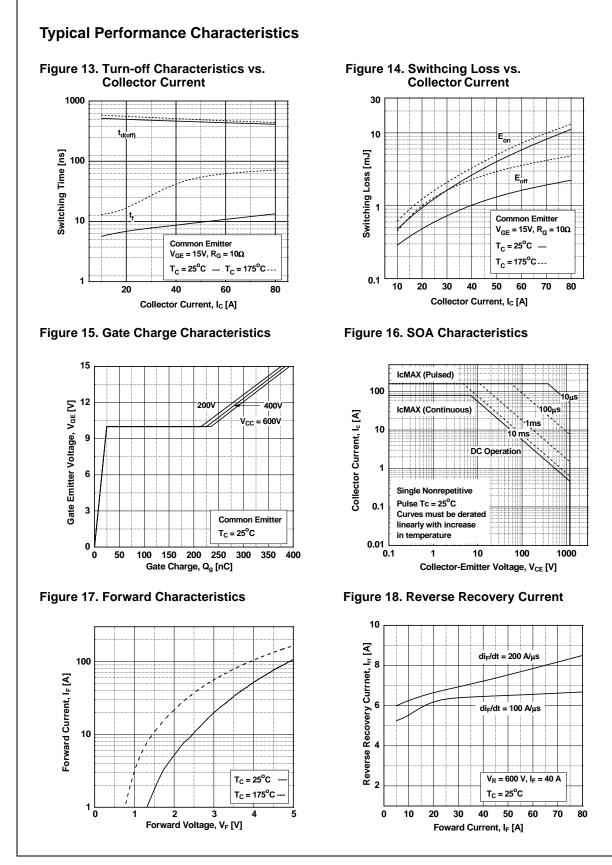
| Symbol          | Parameter                           | Test Conditions  | Min. | Тур. | Max. | Unit |
|-----------------|-------------------------------------|--|------|------|------|------|
| V <sub>FM</sub> | Diode Forward Voltage               | I <sub>F</sub> = 40 A, T <sub>C</sub> = 25°C               | -    | 3.8  | 4.8  | V    |
|                 |                                     | I <sub>F</sub> = 40 A, T <sub>C</sub> = 175 <sup>o</sup> C | -    | 2.7  | -    | V    |
| t <sub>rr</sub> | Diode Reverse Recovery Time         | V <sub>R</sub> = 600 V, I <sub>F</sub> = 40 A,             | -    | 65   | -    | ns   |
| l <sub>rr</sub> | Diode Peak Reverse Recovery Current | $di_F/dt = 200 A/us, T_C = 25^{\circ}C$                    | -    | 7.2  | -    | А    |
| Q <sub>rr</sub> | Diode Reverse Recovery Charge       |  | -    | 234  | -    | nC   |
| t <sub>rr</sub> | Diode Reverse Recovery Time         | $V_{R} = 600 \text{ V}, I_{F} = 40 \text{ A},$             | -    | 200  | -    | ns   |
| I <sub>rr</sub> | Diode Peak Reverse Recovery Current | $di_{F}/dt = 200 \text{ A/us}, T_{C} = 175^{\circ}C$       | -    | 18.0 | -    | А    |
| Q <sub>rr</sub> | Diode Reverse Recovery Charge       |  | -    | 1800 | -    | nC   |

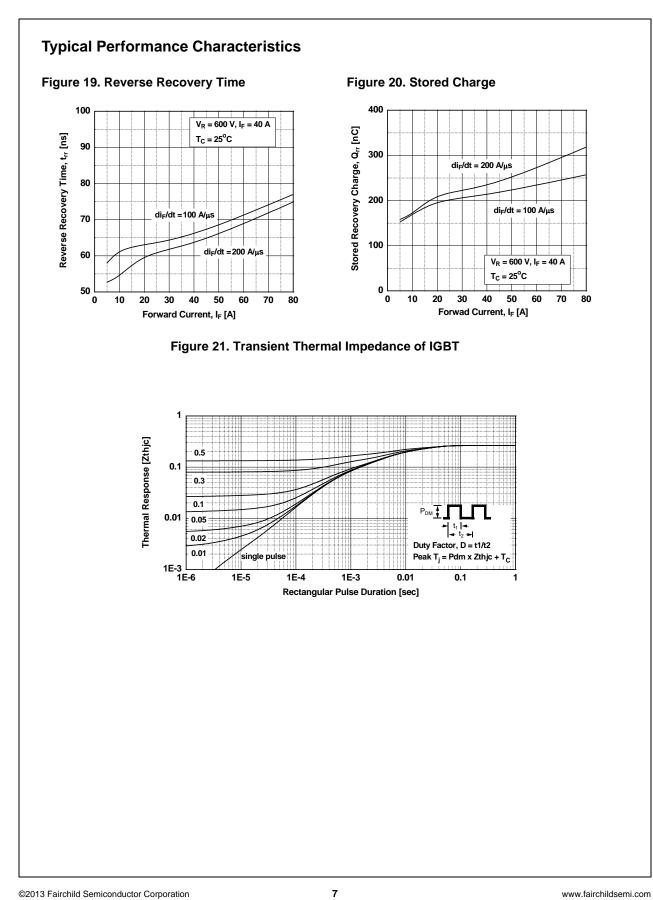


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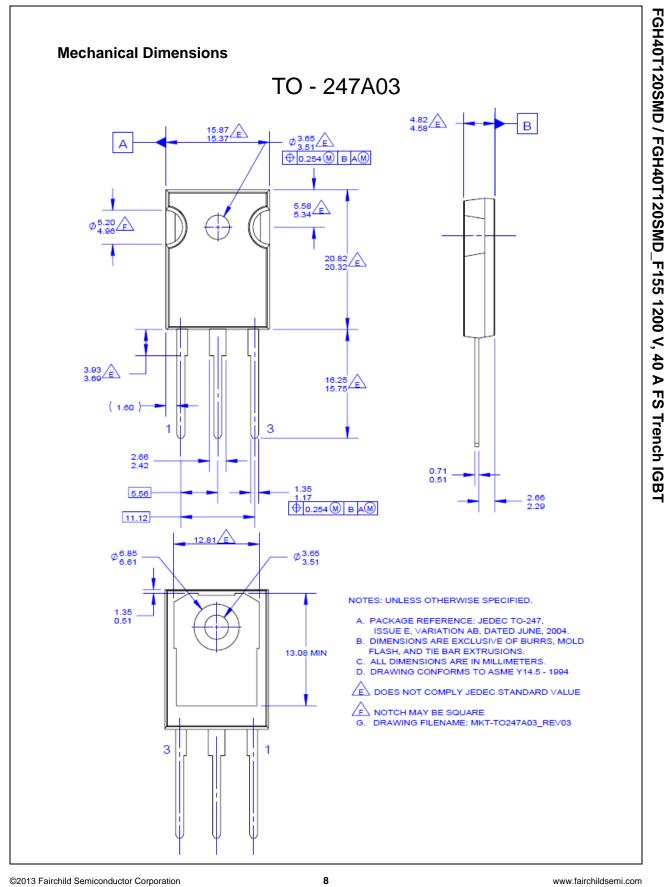
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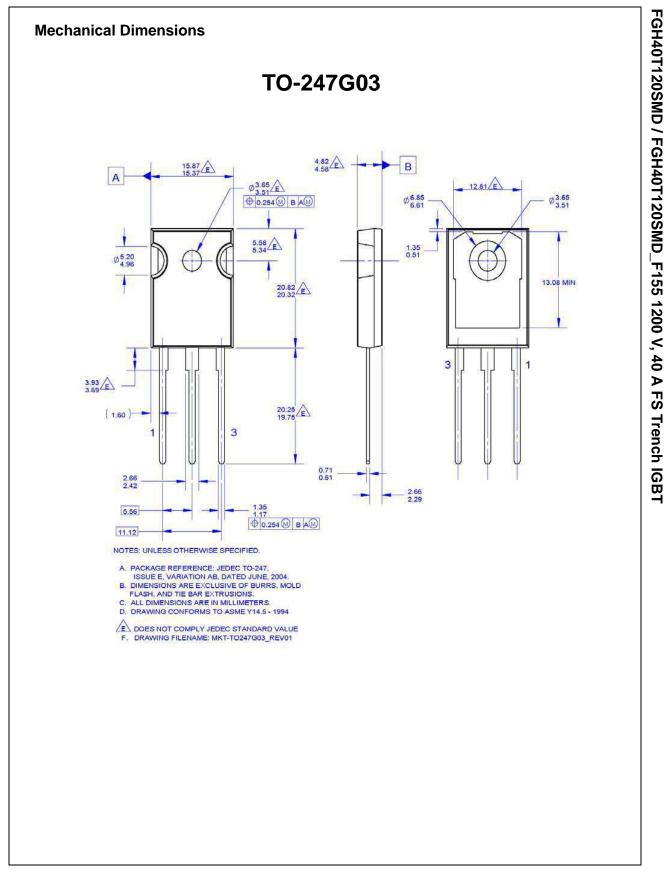


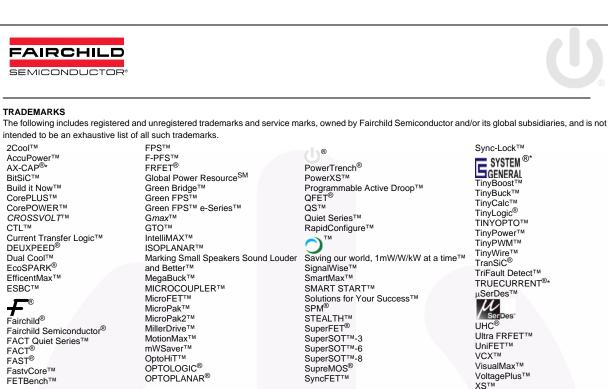


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